Thermal Adhesives - heatsink interface material

AAVID THERMALLOY			Tel (tol	I-free): +1-855-32-AAVID	h		Register Log in
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		xcellent heat transfer e, and coefficients of	and high voltage isola thermal expansion co	mparable to cop	Ente pric	eck Stock er a part number for ing and availability. go!	
Ther-O-Bor	nd 1500	aluminum. They b Ther-O-Bond	-	, glass, ceramics, and	l most plastics.	R	tequest a Sample 🕨
Ther-O-Bond 1600			eet for Ther-O-Bond 1 eet for Ther-O-Bond 1				Request a Quote 🕨
Thermalbor	nd	Ther-O-Bond 150 performance, proc and rapid air evac	0 is a versatile epoxy duction potting and en- cuation are required.	casting system devel ncapsulating application This formulation has a affords excellent air n	ons where low sh very low surface		Ask an Engineer ►

Description	Part Number	RoHS	PCN	Package/Kit	Size
Ther-O-Bond 1500	159900F00000G	RoHS √ Compliant	Product Change Notice	Resin and Hardener	.946 liter (1 Qt.)

1500 adhers to rigid plastics and laminates, metals and ceramics, has a low coefficient of thermal expansion and is readily machined and shaped with ordinary shop tools. The fully cured epoxy system is an excellent electrical insulator which provides good resistance to electrolysis, leakage and corrosion room water, weather,

Handling Characteristics

gases and chemical compounds.

Ordering Information

Mix Ratio by Weight, Resin to Hardener:	100 to 15
Mixed Viscosity @ 25°C, cps:	1000 - 1500
Work-Life @ 25℃	45 Minutes
Gel Time @ 25℃	3-6 Hours
Cure Schedule @ 25℃	8 Hours
Cure Schedule @ 65℃	1 Hour
Cure Schedule @ 100 ℃	0.5 Hour

Physical Properties

i nysicari roperties	
Color	Black
Specific Gravity	1.50
Operating Temp, ℃	-60 to 155
Heat Distortion Temp, °C	100
Hardness, Shore D:	88
Thermal Conductivity W/(m°C)	1.26
Compressive Strength, psi	14,000
Dissipation Factor, 100 KIIz @25℃	0.01
Self Extinguishing?:	yes
C.T.E. (ppm/°C)	25
Tensile Strength (@25℃)	9200 psi

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Dielectric Strength (volts/mil)	800
Shelf Life (DOM)	12 months1

(1) Stated shelf life is from date of manufacture. To allow for inventory cycle, product shipped from Aavid will have less than 12 months remaining shelf life. Aavid guarantees a minimum of 3 months remaining shelf life. Please adjust order quantity so all product will be consumed with in 3 months of date of shipment.

Ther-O-Bond 1500 Resistance Calculator

Formula	
Interface Resistance =	
	Calculate
Enter the grease thickness:	mm
Enter the area of the device that will contact the heat sink:	mm2

interface resistance= interface thickness (mm) * 1000 thermal conductivity (W/m-K) * contact area (mm²)

Ther-O-Bond 1600

MSDS Safety Sheet for Ther-O-Bond 1600 Resin in PDF format MSDS Safety Sheet for Ther-O-Bond 1600 Hardener in PDF format For smaller applications, Ther-O-Bond 1600 produces a stable, durable, high-impact bond, with good heat transfer characteristics. It is a thixotropic (smooth paste) thermally conductive epoxy system used for staking thermistors, diodes, resistors, integrated circuits and other heat sensitive components to printed circuit boards. This two-part adhesive develops strong, durable, high impact bonds at room temperature, which improve heat transfer while maintaining electrical insulation. Therobond 1600 bonds readily to itself, to metals, silica, steatie, alumina, sapphire and other ceramics, glass, plastics and many other materials because its coefficient of thermal expansion provides a good match for those materials over a fairly wide temperature range.

Ordering Information

Description	Part Number	RoHS	PCN	Package/Kit	Size
Ther-O-Bond 1600	161000F00000G	RoHS √ Compliant	Product Change Notice	2-Part Plastic Kit	10gm (.35 oz.)
Ther-O-Bond 1600	164000F00000G	RoHS √ Compliant	Product Change Notice	2-Part Plastic Kit	40gm (1.40 oz.)

Handling Characteristics

Mix Ratio by Weight, Resin to Hardener:	100 to 5
Mixed Viscosity @ 25 °C, cps:	33,000
Work-Life @ 25 °C	45 Minutes
Gel Time @ 25℃	3-6 Hours
Cure Schedule @ 25℃	8 Hours
Cure Schedule @ 65℃	1 Hour
Cure Schedule @ 100 ℃	0.5 Hour

Physical Properties

Physical Properties	
Color	Blue
Specific Gravity:	2.30
Operating Temp, ℃	-70 to 115
Hardness, Shore D:	90
Izod impact, F1 Lbs/Inch of Notch	0.49
Thermal Conductivity W/(m-℃)	0.85
C.T.E. (ppm/°C)	25
Tensile Strength (@25℃)	9200 psi
Tensile Lap Shear, psi	2900
Dielectric Strength (volts/mil)	410
Dielectric Constant (1 KHz @ 25℃)	5.9
Dissipation Factor, KH@ 25℃	5.9
Shelf Life (DOM)	18 months1

(1) Stated shelf life is from date of manufacture. To allow for inventory cycle, product shipped from Aavid will have less than 18 months remaining shelf life. Aavid guarantees a minimum of 3 months remaining shelf life. Please adjust order quantity so all product will be consumed with in 3 months of date of shipment.

Ther-O-Bond 1600 Resistance Calculator

Enter the area of the device that will contact the heat sink:	mm2
Enter the grease thickness:	mm
	Calculate
Interface Resistance =	

Formula

Thermalbond™

Thermalbond[™] is a thermally conductive, high strength epoxy adhesive. It provides exceptional adhesion to copper, aluminum, steel, glass, ceramics, and most plastics. Thermalbond also has a coefficient of thermal expansion compatible with aluminum, copper, and brass, making it particularly well suited for thermally bonding semiconductors and other components to chassis or heat sinks.

Mixing Instructions:

Mix resin thoroughly before removing material. Add 7.1 parts of RT-7 hardner to 100 parts of resin by weight, or 17 parts of RT-7hardener to 100 parts of resin by volume. Adhesive will set up in: 24 hrs at 25 ℃ (77 °F) 1 hr. at 100C (212 °F) 2 hrs. at 65 ℃ (149 °F) 30min. at 130 ℃ (266 °F)

Note: For maximum electrical and physical properties, a post cure is neccessary. Post cure at room temperature for 4 days or for 4 hours at 93 °C (200 °F).

Hardener	Turingly/share
Characteristics	Typical Values
Specific gravity	2.35
Working viscosity	25,000 cps
Thermal conductivity	1.34Wm-1℃-1 (.77 Btu/hr •ft• ℉)
Thermal resistivity	29.4℃ in/watt
Tensile strength	6.34 x 107Pa(9,200 psi)
Compressive strength	1.44 x 108Pa(20,900 psi)
Bond shear strength	3.17 x 107Pa(4,600 psi)
aluminum to aluminum, 25.4mm (1") overlap @	25℃, (77℉)
Thermal coefficient of expansion	24 x 10-6/°C (1.32 x 10-6/°F
Water absorption, % after 10 days@ 25 $^\circ C$ (77 $^\circ$ F)	.20
Hardness, Shore D	86
Volume resistivity	1.0 x 1016
Dielectric strength	59.1 x 103volts/mm (1500 volts/mil)
Dielectric constant@25℃ (77°F) 100KHz	6.1
Dielectric factor@25℃ (77°F) 100KHz	0.020
Operating temperatures	-65 ℃ to 155 ℃ (-85 ℉ to 311 ℉)
Linear shrinkage	0.002 in/in
Shelf life (DOM)	12 months1
Pot life@25℃ (77℉)	2-3 hours
Suggested stripping agent	Miller-Stephenson MS 111
Cleaning solvent	Acetone

Typical Electrical and Physical Properties at Room Temperature with RT-7
Hordopor

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Thermalbond Resistance Calculator

Enter the area of the device that will contact the heat sink:	mm2
Enter the grease thickness:	mm
	Calculate
Interface Resistance =	

Formula

interface resistance= interface thickness (mm) * 1000 thermal conductivity (W/m-K) * contact area (mm²)

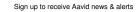
Part No.	RoHS	PCN	Net Weight	MSDS Safety Sheets
4949G	RoHS √ Compliant	Product Change Notice	25 grams (.875 oz) in single use package	Hardener Epoxy

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4950G Part Discontinued	RoHS √ Compliant	Product Change Notice	50 grams (1.75 oz) in single use package	Hardener Epoxy
4951G	RoHS √ Compliant	Product Change Notice	100 grams (3.5 oz) in single use package	Hardener Epoxy
4952G	RoHS √ Compliant	Product Change Notice	200 grams (7.0 oz) in single use package	Hardener Epoxy
4953G	RoHS √ Compliant	Product Change Notice	3.25 lbs.	Hardener Epoxy

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